

Features and Benefits

- Based on advanced magnetic field sensing technology
- Measures magnetic field direction rather than field intensity
- Non-contacting angle measurement
- Large air gap
- Excellent accuracy, even for weak magnetic field
- Position tolerant
- Single chip solution
- User programmable resolution & zero / index position
- RoHS Compliant 2011/65/EU

Applications

- Replacement of optical encoders
- Robotics control
- BLDC motor commutation
- Power tools

General Description

The MagnTek rotary position sensor MT6804 is an IC based on advanced magnetic field sensing technology. The sensor contains two Wheatstone bridges formed by a magnet field sensing element array. A rotating magnetic field in the x-y sensor plane delivers two sinusoidal output signals indicating the angle (α) between the sensor and the magnetic field direction. Within a homogeneous field in the x-y plane, the output signals are relatively independent of the physical placement in the z direction (air gap).

The sensor is only sensitive to the magnetic field direction as the sensing element output is specially designed to be independent from the magnet field strength. This allows the device to be less sensitive to magnet variations, stray magnetic fields, air gap changes and off-axis misalignment.

Three incremental output modes are available in this sensor series, making the chip suitable to replace various optical encoders.



Pin Configuration

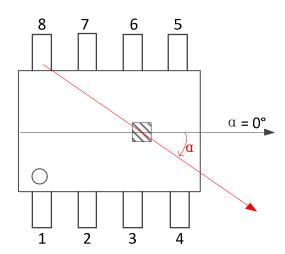


Figure 1: Pin Configuration for SOP-8 Package, Showing Zero Degree Position

Name	Number	Туре	Description
MODE	1	Digital input	Connect to logic low for normal operation; Connect to logic high for I ² C mode.
NSP	2	Digital input or Analog output	Optional magnetic switch input or linear output
GND	3	Ground	Ground
VDD	4	Supply	5V supply
Z/W/Index	5	Digital output	Z or W or Index output
HVPP	6	Supply	7.5 supply only needed for NVM programming. NC for normal operation.
B/V/Dir/SCL	7	Digital I/O	B or V or Dir output or I ² C clock
A/U/Step/SDA	8	Digital I/O	A or U or Step output or I ² C data

Family Members

Part number	Description
MT6804CT-XYZ	SOP-8 package, tape and reel packaging (3000pcs/bag)
MTT6804CT-XYZ	Automotive requirement apply, SOP-8 package, tape and reel packaging
	(3000pcs/bag)

X: Output type, A=ABZ, U=UVW

Y (ABZ or SDI mode): Resolution, 8=8-bit, 9=9-bit, A=10-bit, B=11-bit, C=12-bit

Z: Options, H=default, L=Linear output enabled, F=Full 360-degree detection

Functional Description



The MT6804 is manufactured in a CMOS standard process and uses advanced magnet sensing technology to sense the magnetic field distribution across the surface of the chip. The integrated magnetic sensing element array is placed around the center of the device and delivers a voltage representation of the magnetic field at the surface of the IC.

Figure 2 shows a simplified block diagram of the chip, consisting of the magnetic sensing element realized by two interleaved Wheatstone bridges to generate cosine and sine signals, gain stages, analog-to-digital converters (ADC) for signal conditioning, and a digital signal processing (DSP) unit for encoding. Other supporting blocks such as LDO, etc. are also included.

A small low cost diametrically magnetized (two-pole) standard magnet can be used to provide angular position information. The MT6804 senses the rotation and orientation of the magnetic field and generates incremental outputs. The following 3 incremental output modes are available.

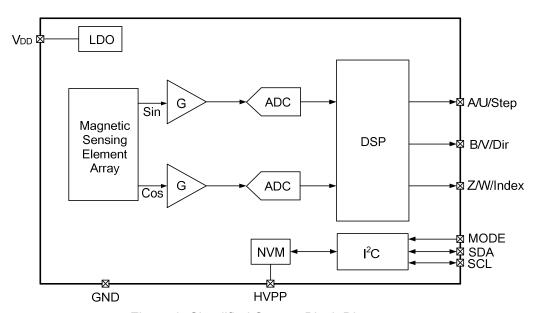


Figure 2: Simplified System Block Diagram

Quadrature A/B and Zero-position output signal

As depicted in

Figure 3, when the magnet rotates clock-wise (CW), output A leads output B by 1/4 cycle (or 1 LSB); When the magnet rotates counter-clock-wise (CCW), output B leads output A by 1/4 cycle. Output Z indicates the zero position of the magnet and has a pulse width of 1 LSB. It is guaranteed that one Z pulse is generated for every rotation. The zero position is user-programmable, but it is recommended to keep it within +/-30 degrees from the original position as shown in Figure 1.

Step / Direction and Index output signal

In this mode, output Step has a pulse width of 1 LSB; Output Dir indicates the direction of the magnet rotation; Output Index is the same as output Z in Quadrature A/B mode.



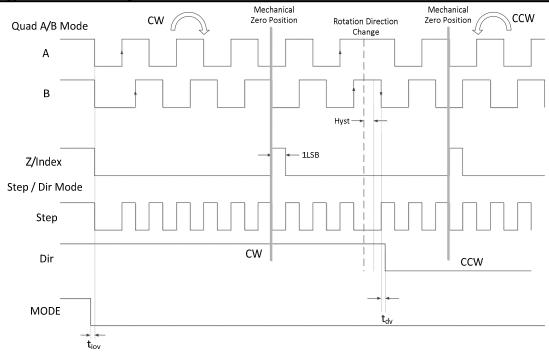


Figure 3: Typical Output Waveform for A/B/Z and Step/Dir/Index mode

3-phase Commutation for Brushless DC Motors (U/V/W)

As depicted in Figure 4, output U, V and W are 120 degrees (electrical) out of phase. The number of pulses per rotation can be programmed to 2, 4, 6 or 16. Pin-out definition varies with the number-of-pulse selection as follows.

Number-of-pulse	U	V	W
2, 6, 16	Pin 8	Pin 7	Pin 5
4	Pin 5	Pin 7	Pin 8

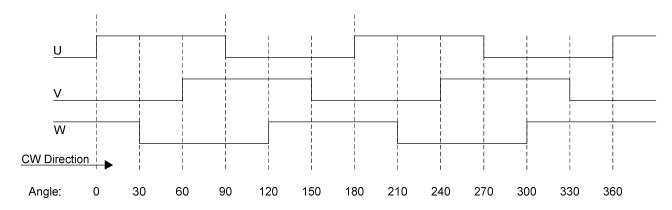


Figure 4: Typical Output Waveform for U/V/W mode



Absolute Maximum Ratings (Non-Operating)

Stresses beyond those listed under "Absolute Maximum Ratings "may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under "Operating Conditions" is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Parameter	Notes	Min	Max	Unit
DC voltage at pin VDD	-	-0.3	8	V
DC voltage at pin HVPP	-	-0.3	8	V
Storage temperature	-	-55	160	°C
Operating Temperature	-	-40	150	°C
Electrostatic discharge (HBM)	Norm: AEC-Q100-2	-	± 4	kV

Electrical Characteristics

Operating conditions: Ta= -40 to +150°C, VDD= 3.0-5.5V unless otherwise noted.

Symbol	Parameter	Conditions/Notes	Min	Тур	Max	Unit	
VDD	Supply Voltage	-	3.0	5	5.5	V	
HVPP	Supply Voltage	-	7.25	7.5	7.75	V	
ldd	Supply Current	-	-	3.0	4.0	mA	
LSB		8-bit	-	1.406	-	Degrees	
LSB		9-bit	ı	0.703	-	Degrees	
LSB	Resolution	10-bit	-	0.352	-	Degrees	
LSB	(ABZ or SDI mode)	11-bit	-	0.176	-	Degrees	
LSB		12-bit	ı	0.088	-	Degrees	
INL	Integral Non-Linearity	Note (1)	-	±1	±1.5	Degrees	
DNL	Differential Non-Linearity	8, 9, 10-bit	ı	1	±0.1	LSB	
DINL	(ABZ mode)	11, 12-bit	-	-	±0.5	LSB	
	Transition Noise	ABZ 8, 9, 10-bit or	_	-	0.011	Deg-rms	
TN		UVW mode	•				
		ABZ 11, 12-bit	-	-	0.004	Deg-rms	
Hyst	Hysteresis	8, 9-bit	-	0.5	-	LSB	
Tiyst	(ABZ mode)	10, 11, 12-bit	-	0.75	-	LSB	
T_{PwrUp}	Power-up Time	-	ı	1	1.1	ms	
		ABZ 8, 9, 10-bit or		160	200	μs	
T _{delay}	Propagation Delay	UVW mode	•	160	200		
		ABZ 11, 12-bit	-	1100	1140	μs	
Digital I/O Characteristics (Push-Pull Type in Normal Mode)							
V _{IH}	High level input voltage	-	VDD-1	-	-	V	
V_{IL}	Low level input voltage	-	-	-	8.0	V	
V _{OH}	High level output voltage	I _{OH} =4.1mA	VDD-1	-		V	



V _{OL}	Low level output voltage	I _{OL} =3.3mA	-	-	0.4	V
I_{LK}	Input Leakage Current -		-	-	±1	μA
Timing Sp	Timing Specifications					
t _{iov}	Incremental Output Valid	-	-	-	1	μs
	Time					
t _{dv}	Dir Signal Valid Time	-	-	-	10	μs

Notes: (1) The typical error value can be achieved at room temperature and with no off-axis misalignment error. The max error value can be achieved over operation temperature range, at maximum air gap and with worst-case off-axis misalignment error.

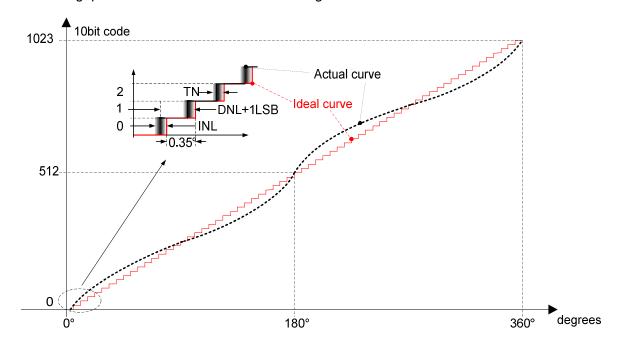


Figure 5: Drawing illustrating INL, DNL and TN (for 10-bit case)

Magnetic Input Specification

Operating conditions: Ta= -40 to +150°C, VDD= 3.0-5.5V unless otherwise noted. Two-pole cylindrical diametrically magnetized source.

Symbol	Parameter	Notes	Min	Тур	Max	Unit
Dmag	Diameter	Recommended magnet: Ø8mm x 2.5mm for cylindrical magnets	-	8	-	mm
Tmag	Thickness	-	-	2.5	-	mm
Bpk	Magnetic input field amplitude	Measured at the IC surface.	300	-	3000	Gauss
AG	Air Gap	Magnet to IC surface distance (Figure 6).	1.0	-	3.0	mm
RS	Rotation Speed	8, 9, 10-bit resolution or UVW mode	-	-	15	KRPM
		11, 12-bit resolution	-	-	7	KRPM





DISP	Displacement Radius	Misalignment error between sensor center and magnet axis (Figure 6).	-	-	0.3	mm
TCmag1	Recommended	NdFeB (Neodymium Iron Boron)	-	-0.12	-	
TCmag2	magnet material and temperature drift	SmCo (Samarium Cobalt)	-	-0.035	-	%/°C

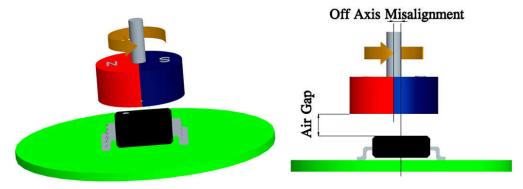


Figure 6: Magnet Arrangement

Application Information

Reference Circuit

Figure 7 shows a reference circuit for typical applications. A ferrite bead (FB1) and a TVS diode (D1) are added for supply transient protection and filtering. For applications where heavy resistive or capacitive load need to be driven, it is recommended that external driver composed of transistors be added at the outputs. The reference circuit shown also applies to applications that use SDI or UVW output, where pin assignment may differ (please refer to the previous section for details).

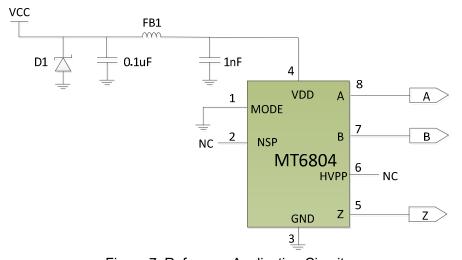


Figure 7: Reference Application Circuit



Magnet Selection and Placement

It is recommended that the magnetic field density at the chip surface reaches 300 Gauss to guarantee that the magnetic sensing elements operate in saturation mode to ensure good linearity. Please be noted that the sensing element in the chip is not at the package center, rather it is aligned with PIN 3 and 6 edges (see the figures in the "Package Information" section). It is required that the magnet's center axis be aligned with the sensing element center. Any misalignment introduces additional angle error. Magnets with larger radius are more tolerant to off-axis misalignment. It also allows the magnet to be placed at the large air gap distance from the chip.

Programming

MT6804 can be programmed through dedicated programmer PB02 with its companion GUI software. The following parameters can be programmed: resolution, output mode, zero position, external MS input and optional linear output.

Optional Linear Output

For applications that need to obtain the absolute angle position of the magnet at power-up, an optional linear output is available to achieve this goal. MT6804 can be programmed to put out an analog voltage that is proportional to the angle position on NSP pin. For more details about how to use the linear output, please contact Magntek's technical support team.

Delay-Induced Angle Error

Sampling and signal processing introduce propagation delay in the chip, which can cause angle error for a continuously rotating magnet. The amount of angle error induced is proportional to the rotation speed Spd (in rpm) and delay time T_{delay} (in seconds). For example, a delay time of 100 us at a rotation speed of 1000 rpm leads to 0.6 degrees of error. The general formula is as follows.

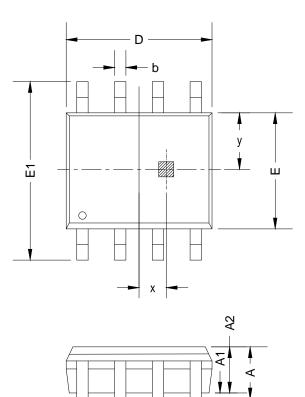
$$e = 6 \cdot Spd \cdot T_{delay}$$

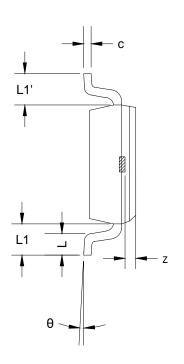
If the speed is steady and the delay is known, this error is predictable, hence can be compensated in the controller stage in the system.



PACKAGE DESIGNATOR

(MT6804CT) SOP-8





Symbol	Dimensions in	Millimeters	Dimensions in Inches		
Symbol	Min	Max	Min	Max	
Α	1.595	1.775	0.063	0.070	
A1	0.050	0.150	0.002	0.006	
A2	1.350	1.550	0.053	0.061	
b	0.375	0.425	0.015	0.017	
С	0.170	0.250	0.007	0.010	
D	4.700	5.100	0.185	0.200	
E	3.875	3.925	0.153	0.155	
E1	5.800	6.200	0.228	0.244	
е	1.270	(BSC)	0.050(BSC)		
L	0.615	0.765	0.024	0.030	
L1	1.040	REF	0.04	1REF	
L1-L1'	-	0.120	-	0.005	
Х	0.0	860	0.034		
у	1.900	1.950	0.075	0.077	
Z	0.526	0.609	0.021	0.024	
θ	0°	8°	0°	8°	